FORM!	PTO-139	390 (Modified) U.S. DEPARTMENT OF COMMERCE PATENT AND TRADEMARK OFFICE )	ATTORNEY'S DOCKET NUMBER
(Kb+.	TI	RANSMITTAL LETTER TO THE UNITED STATES	213512US0XPCT
ν.	7	DESIGNATED/ELECTED OFFICE (DO/EO/US)	U.S. APPLICATION NO. (IF KNOWN, SEE 37 CFR
	<i>p</i> ⊷ 	CONCERNING A FILING UNDER 35 U.S.C. 371	09/926132
INTE	RNAT	TIONAL APPLICATION NO. INTERNATIONAL FILING DATE PCT/FR00/00665 17 M arch 2000	PRIORITY DATE CLAIMED 19 March 1999
	E OF I	INVENTION	
		SS FOR MANUFACTURING A SILICONE PART INTENDED TO D	
		DHESIVE ASSEMBLY MANUFACTURED ACCORDING TO THE	₹ PROCESS
		NT(S) FOR DO/EO/US LLIER Yves et al.	17
Lii	· Y ->	LIER Yves et ai.	
Appl	icant '	herewith submits to the United States Designated/Elected Office (DO/EO/US) th	ne following items and other information:
1.	×	This is a <b>FIRST</b> submission of items concerning a filing under 35 U.S.C. 371.	_
2.		This is a <b>SECOND</b> or <b>SUBSEQUENT</b> submission of items concerning a filing.	
3.	$\boxtimes$	This is an express request to begin national examination procedures (35 U.S.C.	-
		(6), (9) and (24) indicated below.	`"
4.		The US has been elected by the expiration of 19 months from the priority date	(Article 31).
	$\boxtimes$	A copy of the International Application as filed (35 U.S.C. 371 (c) (2))	
11,5 11,5		a.  is attached hereto (required only if not communicated by the Internat	tional Bureau).
		b. \( \text{has been communicated by the International Bureau.} \)	
		c. is not required, as the application was filed in the United States Recei	- , ,
16.	$\boxtimes$	An English language translation of the International Application as filed (35 U	J.S.C. 371(c)(2)).
		a. 🗵 is attached hereto.	
		b. $\square$ has been previously submitted under 35 U.S.C. 154(d)(4).	
47.	X	Amendments to the claims of the International Application under PCT Article	
113		a.   are attached hereto (required only if not communicated by the Internation of the Int	ational Bureau).
47.		b.  have been communicated by the International Bureau.	
Title Market		c. have not been made; however, the time limit for making such amendr	ments has NOT expired.
2115	_	d. A have not been made and will not be made.	
\$8 <u>.</u>		An English language translation of the amendments to the claims under PCT A	article 19 (35 U.S.C. 371(c)(3)).
9.	X	An oath or declaration of the inventor(s) (35 U.S.C. 371 (c)(4)).	
10.	×	An English language translation of the annexes of the International Preliminary Article 36 (35 U.S.C. 371 (c)(5)).	•
11.	$\boxtimes$	A copy of the International Preliminary Examination Report (PCT/IPEA/409).	•
12.	$\boxtimes$	A copy of the International Search Report (PCT/ISA/210).	
Ite		13 to 20 below concern document(s) or information included:	
13.		An Information Disclosure Statement under 37 CFR 1.97 and 1.98.	
14.		An assignment document for recording. A separate cover sheet in compliance	with 37 CFR 3.28 and 3.31 is included.
15.		A FIRST preliminary amendment.	
16.		A SECOND or SUBSEQUENT preliminary amendment.	
17.		A substitute specification.	
18.		A change of power of attorney and/or address letter.	
19.		A computer-readable form of the sequence listing in accordance with PCT Rule	
20.		A second copy of the published international application under 35 U.S.C. 154(d	
21.		A second copy of the English language translation of the international applicati	ion under 35 U.S.C. 154(d)(4).
22.		Certificate of Mailing by Express Mail	
23.		Other items or information:	
		Notice for Consideration of Documents Cited in International Search Repo PCT/IB/304/Drawings (1 Sheet)/PCT/IB/308/Amended Sheets (Pages 8 and Cited Pending Applications (2)	

U.S. A	PPLICATIO	09/926132	INTERNATIONAL AI PCT/FR			NO.		DOCKET NUMBER USOXPCT
24.	The fo	ollowing fees are submitted:.	<u> </u>				CALCULATIONS	PTO USE ONLY
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	Internation and all clai	al preliminary examination fee (37 ms satisfied provisions of PCT Art	ticle $33(1)$ - $(4)$			\$100.00		
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## Process for manufacturing a silicone part intended to be adhesively bonded and self-adhesive assembly manufactured according to the process

- invention relates to any molded part, made of silicone, intended to be mounted by adhesive bonding on a substrate, for example in order to constitute a seal.
- It is known that silicone parts can be adhesively 10 bonded only with a silicone-based adhesive, the latter adhering to the silicone part only if it cures after having been brought into contact with the part.
- It is known practise to use silicone molded parts as 15 seals, blocking joints, dampers, stops, etc.

It is known practise either to premold the part and then bond it to its substrate or to overmold the part directly onto its substrate.

In the case of premolding the part followed by adhesive bonding, a layer of silicone adhesive is deposited on the substrate at that point where the silicone molded part must be placed, the molded part is then positioned 25 and time must elapse for the adhesive to cure. This bonding process has several drawbacks: the cure time of the adhesive is long; a specific tool for positioning the part is required and this tool is tied up while the curing takes place; and there is the difficulty of having an adhesive layer which is uniform in thickness and does not spill over.

In the case of overmolding, a thin silicone adhesive or more precisely an adhesion primer, deposited on the substrate at the point where the 35 silicone molded part must be located. This layer is then left to dry for a time varying from about a quarter of an hour to about three quarters of an hour, depending on its composition and ambient the

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temperature. A mold whose hollow cavity corresponds to the silicone part covers the adhesive-coated portion and silicone resin is injected into the mold. After the resin has cured, the mold is removed. This bonding process also has drawbacks: time must be allowed for the adhesion primer layer to dry; and an even longer time must be allowed for the curing to take place, during which time the tied-up mold cannot be used elsewhere; and this is a mold which is often complex and expensive.

It is an object of the present invention to avoid, or at the very least to reduce, these drawbacks by providing a manufacturing process which results in a self-adhesive assembly.

The invention relates to a process for manufacturing a silicone molded part intended to be fastened to another part by adhesive bonding, said silicone part being, at the end of the process, in the form of a self-adhesive assembly, characterized in that it comprises at least the following steps:

- \* using a mold having a hollow cavity, the dimensions of which are approximately equal to those of the self-adhesive assembly;
- \* using adhesive bonding means consisting of a stack comprising, in succession, at least a protective sheet, a layer of a first adhesive, an intermediate sheet and a layer of a second adhesive, said second adhesive being silicone-based;
- \* placing said adhesion means in said mold, the protective sheet being in contact with one of the walls of the hollow cavity;
- \* injecting a silicone resin into the space left free inside the mold by said adhesion means; and
  - \* curing the self-adhesive assembly, formed from the adhesion means and the silicone resin, and then demolding it.

The invention also relates to a self-adhesive assembly comprising at least one part intended to be fastened to another part and double-sided adhesive bonding means made from a stack comprising, in succession, protective sheet, a layer of a first adhesive, intermediate sheet and a layer of a second adhesive in contact with the part to be bonded, characterized in that the part to be adhesively bonded is a silicone part and in that the second adhesive is silicone-based.

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invention will be more clearly understood and further features will become apparent from the following description and from figure 1, appended hereto, which shows, seen in cross section, means used in the process.

To allow a silicone part to be rapidly bonded to another part without tieing for a long period the positioning equipment used during industrial-scale manufacture, it is proposed below to produce selfadhesive assemblies in which the silicone part is combined with a double-sided self-adhesive strip during its molding.

25 Since molding techniques are assumed to be known to the reader, certain details such as the resin injection into a mold or the retention of a sheet against the internal wall of a mold by suction, will be mentioned without going into the implementation details.

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The silicone parts produced according to the process may either be parts molded directly to the desired dimensions or sheets designed to be cut subsequently to the desired dimensions.

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Figure 1 shows. in cross-sectional self-adhesive assembly and a mold  ${\tt M}$  used to manufacture the self-adhesive assembly.

The mold M is formed from two half-shells M1, M2 which, when they are joined together, as shown in the figure, constitute a cavity with, on the inside, a space bounded by "the hollow cavity"  $(E_1, E_2)$  of the mold. The dimensions of the hollow cavity correspond approximately to the dimensions of the self-adhesive assembly to be obtained.

- The self-adhesive assembly, as shown in the figure, consists of a stack comprising, in succession, a protective sheet Fp, a layer Ce of a first adhesive, an intermediate sheet Fi, a layer Cs of a second adhesive and the part R made of silicone resin.
- 15 manufacturing process consists, after The having produced the mold M, in obtaining the double-sided adhesive, Ce + Fi + Cs, with its protective sheet Fp. The adhesive of the layer Cs is a substance compatible with silicone, that is to say a silicone-based adhesive. The substances used in the process are chosen to be compatible with the mechanical, thermal, chemical and other properties of the desired self-adhesive assembly. The illustrative example serving for the present description will be commented upon in greater 25 detail below.

During one step of the process, the double-sided adhesive (Ce + Fi + Cs) is placed in the half-mold M1 with the protective sheet Fp in contact with the bottom F1 of the cavity E1. The dimensions of the cavity E1 of the half-shell M1 correspond approximately to the dimensions of the assembly consisting of the double-sided adhesive and the protective sheet Fp. That side of the layer Cs furthest away from the bottom F1 is approximately flush with that face of the half-shell M1 which is contact with the half-shell M2.

The half-shell M1 is drilled with several suction ducts (not shown in the figure). These are, as is

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conventional in the art of molding, very fine holes which pass through the half-shell M1 and emerge in the bottom F1 of the hollow cavity  $E_1$  where the protective sheet Fp lies. These holes make it possible, by suction using a pump (not shown), to keep the double-sided adhesive and the protective sheet in place.

When the double-sided adhesive Ce + Fi + Cs is in place, the half-shell M2 is brought against the half-shell M1 with their hollow cavities  $(E_1, E_2 \text{ respectively})$  facing each other, as shown in the drawing. The two half-shells are kept in position by fastening means (not shown) known to those skilled in the art.

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The half-shell M2 is drilled with several injection holes (not shown in the figure). These are, here again as is conventional in the art of molding, a number of holes, some of which are used to inject the material to be molded, in this case silicone resin, and the rest of which are used to allow the air contained in the hollow cavity to escape as it becomes progressively filled with the material to be molded.

25 During a subsequent step, the mold is filled with resin, the assembly is subjected to a curing step and, once the resin has cured, the self-adhesive assembly, comprising the double-sided adhesive, the protective sheet and the silicone resin part, is demolded. This self-adhesive assembly is either ready to be used or 30 ready to be cut to the desired dimensions. To do this, all that is required is to remove the protective sheet Fp in order to be able to position it without any complex tooling and without a waiting time during manufacture, given that the self-adhesive assembly is 35 "ready to stick", unlike, as mentioned previously, silicone parts whose adhesive bonding means are joined to the part only at the moment of bonding.

In the example described, as shown in the figure, the width  $l_1$  of the hollow cavity  $E_1$  of the half-shell M1 is greater than the width  $l_2$  of the hollow cavity  $E_2$  of half-shell M2; this makes it possible, in addition to holding the double-sided adhesive in place by suction, to hold it in place by jamming along its edges.

Again in the case of the example described, the mold M is made of aluminum, a material compatible with silicone, that is to say a material for which there is no problem of any chemical reaction, particularly while the silicone resin is curing. Choosing a compatible material is a manufacturing precaution well known to those skilled in the art of manufacturing molded silicone parts.

The transverse dimensions of the half-molds M1 and M2, namely the width  $l_\text{M}$  and its height  $H_\text{M}$  are 15 cm by 3 cm, respectively.

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The protective sheet Fp and the layer of a first adhesive Ce consist of an adhesive film produced and sold by 3M under the reference VHB 9460; this is an adhesive of constant thickness backed by a protective sheet made of siliconzied paper.

The intermediate sheet Fi and the layer of a second adhesive Cs consist of an adhesive film produced by Protectia under the reference KAPTON 830; this is a KAPTON film coated on one side with a silicone-based adhesive bonding element. It should be noted that the VHB 9460 film is not silicone-based but, as evident from the above, only the layer Cs needs to be made of a silicone-based adhesive, it being understood that the adhesive of the layer Ce needs to adhere to the sheet Fi.

The present invention is not limited to the foregoing; it is possible for the double-sided adhesive to be held

in place in the mold by, for example, lightly bonding it instead of holding it in place by suction.

- Likewise, the transverse dimensions of the cavities of the half-shells M1, M2 may be the same along the parting line of these half-shells, or indeed that of the half-shell M2 may be greater than that of the half-shell M1.
- With regard to the parting lines between M1 and M2 on the one hand and between R and Cs on the other hand, these may be at different levels; thus, for example, the half-shell M1 may be a simple plate and the assembly R + Cs + Fi + Ce + Fp is then entirely housed in the cavity of the half-shell M2, the dimensions and the geometry of which are chosen accordingly.

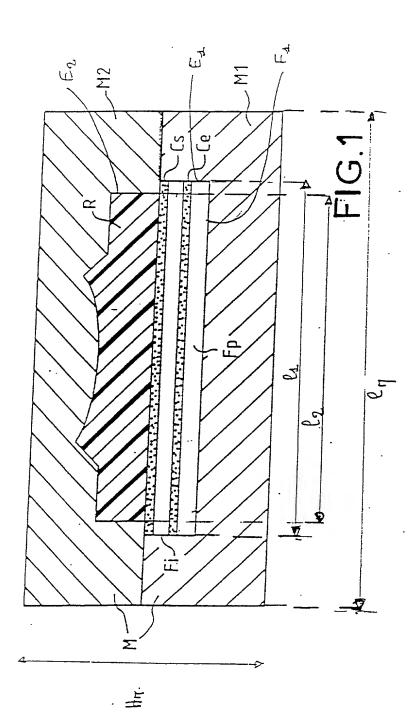
With regard to the various constituents, these will, of course, have to be chosen according to the part to be produced and according to the conditions under which this part is stored and used.

#### CLAIMS

- 1. A process for manufacturing a silicone part intended to be fastened to another part by adhesive bonding, said silicone part being, at the end of the process, in the form of a self-adhesive assembly, characterized in that it comprises at least the following steps:
  - \* using a mold (M) having a hollow cavity  $(E_1, E_2)$ , the dimensions of which are approximately equal to those of the self-adhesive assembly;
  - \* using adhesive bonding means consisting of a stack comprising, in succession, at least a protective sheet (Fp), a layer (Ce) of a first adhesive, an intermediate sheet (Fi) and a layer (Cs) of a second adhesive, said second adhesive being silicone-based;
  - \* placing said adhesion means in said mold (M), the protective sheet (Fp) being in contact with one of the walls of the hollow cavity  $(E_1)$ ;
  - \* injecting a silicone resin (R) into the space left free inside the mold by said adhesion means; and
  - \* curing the self-adhesive assembly, formed from the adhesion means and the silicone resin, and then demolding it.
- The process as claimed in claim 1, characterized in that it includes the use of two adhesives of different types for the first layer (Ce) and for the second layer (Cs), the adhesive of the second layer being silicone-based.
- 3. The process as claimed in claim 1, characterized in that it includes the choice of two films each consisting of a sheet coated with adhesive on one

### AMENDED SHEET

of its sides, one of the two films being used to constitute the protective sheet (Fp) and the layer (Ce) of a first adhesive and the other film being used to constitute the intermediate sheet (Fi) and the layer (Cs) of a second adhesive.



# Declaration and Power of Attorney for Patent Application Déclaration et Pouvoirs pour Demande de Brevet

# French Language Declaration

	En tant l'inventeur nommé cı-après, je déclare par le présent acte que	As a b	pelow named inventor, I hereby declare that		
	Mon domicile, mon adresse postale et ma nationalité sont ceux figurant ci-dessous à côté de mon nom.		sidence, post office address and citizenship are as next to my name		
	Je crois être le premier inventeur original et unique (si un seul nom est mentionné ci-dessous), ou l'un des premiers co-inventeurs originaux (si plusieurs noms sont mentionnés ci-dessous) de l'objet revendiqué, pour lequel une demande de brevet a été déposée concernant l'invention intitulée  PROCESS FOR MANUFACTURING ADHESIVELY BONDED AND SELF	name (if plu which	eve I am the original, first and sole inventor (if only one is listed below) or an original, first and joint inventor trail names are listed below) of the subject matter is claimed and for which a patent is sought on the ion entitled		
	PROCESS FOR MANUFACTURING	G <u>A S</u>	LICONE PART INTENDED TO BE		
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P1,3	ACCORDING TO THE PROCESS				
	et dont la description est fournie ci-joint à moins	the specification of which			
h, j	□ ci-joint		is attached hereto.		
i,,i	a été déposée le	X	was filed on 17 March 2000		
	sous le numéro de demande des Etats-Unis ou le numéro de demande international PCT		as United States Application Number or PCT International Application Number		
	et modifiée le		PCT/FR00/00665 and was amended on		
	(le cas échéant).		(if applicable).		
	Je déclare par le présent acte avoir passé en revue et compris le contenu de la description ci-dessus, revendications comprises, telles que modifiées par toute modification dont il aura été fait référence ci-dessus.	conte	by state that I have reviewed and understand the nts of the above identified specification, including the s, as amended by any amendment referred to above.		
	Je reconnais devoir divulguer toute information pertinente à	I ack	nowledge the duty to disclose information which is		

material to patentability as defined in Title 37, Code of

Federal Regulations, § 1 56.

la brevetabilité, comme défini dans le Titre 37, § 1.56 du

Code fédéral des réglementations

## **French Language Declaration**

Je revendique par le présent acte avoir la priorité étrangère, en vertu du Titre 35, § 119(a)-(d) ou § 365(b) du Code des Etats-Unis, sur toute demande étrangère de brevet ou certificat d'inventeur ou, en vertu du Titre 35, § 365(a) du même Code, sur toute demande internationale PCT désignant au moins un pays autre que les Etats-Unis et figurant ci-dessous et, en cochant la case, j'ai aussi indiqué ci-dessous toute demande étrangère de brevet, tout certificat d'inventeur ou toute demande internationale PCT ayant une date de dépôt précédant celle de la demande à propos de laquelle une priorité est revendiquée.

volontairement fausses risquent de compromettre la validité de la demande de brevet ou du brevet délivré à partir de celle-ci.

I hereby claim foreign priority under Title 35, United States Code, § 119(a)-(d) or § 365(b) of any foreign application(s) for patent or inventor's certificate, or § 365(a) of any PCT International application which designated at least one country other than the United States, listed below, and have also identified below, by checking the box, any foreign application for patent or inventor's certificate, or PCT International application having a filing date before that of the application on which priority is claimed.

Prior Foreign Applicat Demande(s) de breve		n autre pays.		<u>Priority :</u> <u>Droit de</u> <u>reven</u>	
99 03466	FRANCE		19 MARCH 1999	<del>XX</del>	
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(Number) (Numéro) Je revendique par le	(Country) (Pays)		(Day/Month/Year Filed) (Jour/Mois/Anné de dépôt)	☐ Yes Oui	No Non
Je revendique par le 35, § 119(e) du Cor brevet provisoire effe	de des Etats-Unis, d	néfice, en vertu du Titre de toute demande de et figurant ci-dessous	I hereby claim the benefit under T § 119(e) of any United States pro below.		
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§ 35, § 120 du Code d effectuée aux Etats- même Code, de toute Etats-Unis et figurant chacune des revend pas divulgué dans internationale PCT, e graphe du Titre 35, e devoir divulguer tout comme défini dans réglementations, don	es Etats-Unis, de tou Jnis, ou en vertu du e demande internatior ci-dessous et, dans la ications de cette der la demande antér en vertu des disposite (a 112 du Code des E e information pertie le Titre 37, § 156 et t j'ai pu disposer entrure et la date de di	réfice, en vertu du Titre te demande de brevet Titre 35, § 365(c) du nale PCT désignant les a mesure où l'objet de mande de brevet n'est ieure américaine ou ions du premier paratats-Unis, je reconnais ente à la brevetabilité, du Code fédéral des re la date de dépôt de épôt de la demande ente demande.	I hereby claim the benefit under T § 120 of any United States application designation ternational application designation below and, insofar as the subject of this application is not disclosed in the International application in the mean paragraph of Title 35, United States the duty to disclose information which as defined in Title 37, Code of Federal became available between the filing and the national or PCT Internapplication	on(s), or § 365(c) of ng the United State latter of each of the ne prior United State anner provided by Code, § 112, I ackroch is material to pat ral Regulations, § 1.	f any PCT es, listed claims of es or PCT the first nowledge tentability .56 which pplication
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Page 2 of  $\frac{4}{}$ 

## **French Language Declaration**

POUVOIRS: En tant que l'inventeur cité, je désigne par la présente l'(les) avocat(s) et/ou agent(s) suivant(s) pour qu'ils poursuive(nt) la procédure de cette demande de brevet et traite(nt) toute affaire s'y rapportant avec l'Office des brevets et des marquees. (mentionner le nom et le numéro d'enregistrement).

POWER OF ATTORNEY: As a named inventor, I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and transact all business in the Patent and Trademark Office connected therewith: (list name and registration number)

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(Fournier les mêmes renseignements et la signature de tout co-inventeur supplémentaire )

(Supply similar information and signature for third and subsequent joint inventors.)

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Nom complet du cinquième co-inventeur, le c	as echeant	Full name of fifth joint inventor, if any	
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